XR2682

### 3.3V~5V Input 12W Output Step-up DC/DC Converter

## GENERAL DESCRIPTION

The XR2682 is a high frequency, high efficiency DC to DC converter with an integrated $6 \mathrm{~A}, 40 \mathrm{~m} \Omega$ power switch capable of providing an output voltage up to 24 V . The fixed 600 KHz allows the use of small external inductions and capacitors and provides fast transient response. It integrates Soft start, Comp,. only need few components outside.
It can output $6 \mathrm{~V} 2 \mathrm{~A}, ~ 9 \mathrm{~V} 1.3 \mathrm{~A}$ for single battery input. If $\mathrm{Vbat}=3.6 \mathrm{~V}$, it can output 6 V $2.5 \mathrm{~A}, ~ 9 \mathrm{~V} 1.5 \mathrm{~A}$ at good heat dissipation condition.

## FEATURES

- 2.7 V to 5.5 V input voltage Range
- Efficiency up to $96 \%$
- 24 V Boost converter with 6A switch current Limit
- 600KHz fixed Switching Frequency
- Integrated soft-start
- Thermal Shutdown
- Under voltage Lockout
- Upward pin-to-pin compatible XR2981
- 8-Pin SOP-PP Package


## APPLICATIONS

Portable Audio Amplifier Power Supply
Power Bank
QC 2.0/Type C
Wireless Charger
POS Printer Power Supply
Small Motor Power Supply


Figure 1. Typical Application Circuit1
( for Single cell Li-Battery)

XR2682


Figure 2. Typical Application Circuit2
( for Dual cell Li-Battery)

## ORDERING INFORMATION

| PART <br> NUMBER | TEMP RANGE | SWICHING <br> FREQUENCY | OUTPUT <br> VOLTAGE (V) | ILIM (A) | PACKAGE | PINS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| XR2682 | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | 600 KHZ | ADJ | 6 | SOP-PP | 8 |

## PIN CONFIGURATION



Figure 3. PIN Configuration

## PIN DESCRIPTION

| PIN <br> NUMBER | PIN <br> NAME | PIN DESCRIPTION |
| :---: | :---: | :--- |
| 1,2 | SW | lwitch pin |
| 3 | PVDD | Input power supply pin, please connect with Cin close asp |
| 4 | AVDD | Boost IC Logic power supply pin , if far from Cin, please add one 1uF MLCC close asp |
| 5 | EN | Shutdown control input., Connect this pin to logic high level to enable the device |
| 6 | FB | Feedback pin |
| 7 | AGND | Analog ground |
| 8 | PGND | Power ground |
| EPAD | PGND |  <br> Good heat dissipation |

XR2682

## ABSOLUTE MAXIMUM RATINGS

(Note: Do not exceed these limits to prevent damage to the device. Exposure to absolute maximum rating conditions for long periods may affect device reliability.)

| PARAMETER | VALUE | UNIT |
| :--- | :---: | :---: |
| Supply Voltage VIN | -0.3 to 6.5 | V |
| FB, EN Voltage | -0.3 to 6.5 | V |
| SW Voltage | -0.3 to 26 V | V |
| Operating Ambient Temperature | -40 to 85 | ${ }^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | -55 to 150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10 sec ) | 300 | ${ }^{\circ} \mathrm{C}$ |

## ELECTRICAL CHARACTERISTICS

( $\mathrm{V}_{\mathbb{I N}}=3.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise specified)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Voltage Range | $\mathrm{V}_{\text {IN }}$ |  | 2.7 |  | 5.5 | V |
| Boost output voltage range | Vout |  | 24 |  |  | V |
| UVLO Low Threshold | V UvLoL |  |  | 2.6 |  | V |
| UVLO High Threshold | V UvLoh |  |  | 3.2 |  | V |
| Operating Supply Current | $I_{\text {SUPPLY }}$ | $\mathrm{V}_{\mathrm{FB}}=1.5 \mathrm{~V}, \mathrm{EN}=\mathrm{Vin}$, $\mathrm{I}_{\text {Load }}=0$ |  | 100 |  | $\mu \mathrm{A}$ |
| Shutdown Supply Current |  | $\mathrm{V}_{\mathrm{EN}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ |  |  | 1 |  |
| Regulated Feedback Voltage | $\mathrm{V}_{\text {FB }}$ |  | 1.21 | 1.24 | 1.27 | V |
| Peak Inductor Current | $I_{\text {peak }}$ |  |  | 6 |  | A |
| Oscillator Frequency | Fosc |  | 400 | 600 | 800 | KHz |
| Rds(ON) of N -channel FET |  | $\mathrm{I}_{\text {sw }}=1 \mathrm{~A}$ |  | 40 |  | $\mathrm{m} \Omega$ |
| Enable Threshold |  | $\mathrm{V}_{\mathrm{IN}}=2.7 \mathrm{~V}$ to 5.5 V | 0.3 | 1 | 1.5 | V |
| Enable Leakage Current |  |  | -0.1 |  | 0.1 | $\mu \mathrm{A}$ |
| SW Leakage Current |  | $\mathrm{V}_{\mathrm{EN}}=0 \mathrm{~V}, \mathrm{~V}_{\text {SW }}=0 \mathrm{~V}$ or $5 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=5 \mathrm{~V}$ |  |  | 1 | uA |

XR2682


Figure 4. Functional Block Diagram

## FUNCTIONAL DESCRIPTION

## NORMAL OPERATION

The boost converter is designed for output voltage up to 24 V with a $6 \mathrm{~A} / 24 \mathrm{~V}$ power MOSFET. The low $R_{d s o n}$ of the internal power switches enables better power efficiency. The chip, which operates in a current mode scheme with constant frequency 600 KHz . It operates with Pulse With Modulation(PWM). To avoid the inrush current during power up, soft start circuit is integrated in the chip.

The controller circuit of the device is based on a fixed frequency multiple feedback controller topology. Input voltage, output voltage, and voltage drop on the NMOS switch are monitored and feedback to the regulator. So changes in the operating conditions of the converter directly affect the duty cycle and must not take the indirect and slow way through the control loop and the error
amplifier. The control loop, determined by the error amplifier, only has to handle small signal errors. The input for it is the feedback voltage on the FB pin, the voltage on the internal resistor divider. It is compared with the internal reference voltage to generate an accurate and stable output voltage.

## CYCLE BY CYCLE CURRENT LIMIT

The peak current of the NMOS switch is also sensed to limit the maximum current flowing through the switch and the inductor. The typical peak current limit is set to exceed 6A.

## UNDERVOLTAGE LOCKOUT (UVLO)

Under voltage lockout prevents operation of the device at input voltages below typical 2.6 V when the input voltage is falling. When the input voltage is below the under voltage threshold, the device is
shut down and the internal switch FETs are turned off. If the input voltage rises by under voltage lockout hysteresis(3.2V), the IC restarts.

## THERMAL SHUTDOWN

A thermal shutdown is implemented to prevent
damages due to excessive heat and power dissipation. Typically the thermal shutdown threshold is $150^{\circ} \mathrm{C}$. When the thermal shutdown is triggered the device stops switching until the temperature falls below typically $136^{\circ} \mathrm{C}$. Then the device starts switching again.

## APPLICATION INFORMATION

## INDUCTOR SELECTION

In normal operation, the inductor maintains continuous current to the output. The inductor current has a ripple that is dependent on the inductance value. The high inductance reduces the ripple current. Selected inductor by actual application:

| Manufa <br> cturer | Part Number | Inductance <br> (uH) | DRC max <br> (Ohms) | Dimensions <br> $\boldsymbol{L}^{*} \boldsymbol{W}^{*} H(\boldsymbol{m m} 3)$ |
| :---: | :---: | :---: | :---: | :---: |
| TDK | SPM6530T | 2.2 | 0.017 | $7.1^{*} 6.5^{*} 3$ |
|  | CLF10040T | 2.2 | 0.0097 | $10^{*} 9.7^{*} 3.8$ |
| WURT <br> H | 74437349022 | 2.2 | 0.012 | $7.3^{*} 6.6^{*} 4.8$ |
|  | 744311220 | 2.2 | 0.012 | $7.0^{*} 6.9^{*} 3.8$ |

Table 1. Recommend Surface Mount Inductors
Notes: Please select inductor according to \| in. The IL need to be $1.5^{2 *} \mid \mathrm{in}$. For getting higher efficiency, need to use low DRC inductors.

## INPUT CAPACITOR SELECTION

The input capacitor reduces input voltage ripple to the converter, low ESR ceramic capacitor is highly recommended. For audio amplifier applications, A 22uF ceramic capacitor \& 220uF E-cap is needed. Iow ESR tantalum capacitor is recommended for good ripple performance \& dynamic response, The input capacitor should be placed as close as possible to VIN and GND.

## OUTPUT CAPACITOR SELECTION

A low ESR output capacitor is required in order to maintain low output voltage ripple. In the case of ceramic output capacitors, capacitor ESR is very small and does not contribute to the ripple, so a lower capacitance value is acceptable when ceramic capacitors are used. For audio amplifier applications, A 22uF ceramic capacitor \& 220 uF E-cap is needed. low ESR tantalum capacitor is recommended for good ripple performance \& dynamic response.

XR2682

## OUTPUT VOLTAGE PROGRAMMING

In the adjustable version, the output voltage is set by a resistive divider according to the following equation:

$$
R_{1}=R_{2} \times\left(\frac{V_{\text {OUT }}}{1.24}-1\right)
$$

Typically choose $\mathrm{R} 2=10 \mathrm{~K}$ and determine R 1 from the following equation:

## DIODE SELECTION

According to max lout and max Vout, you can select suitable diode. Normally we select diode If=(1.5~2)*loutmax and VR=(1.5~2)*Voutmax. For high efficiency, suggest that you select low Vf Schottky diode.

For example, 3.3V~4.2Vin 6V 2Aout, you can select SS54 or MBRS410. MBRS410 for high efficiency.

## LDO SELECTION

For Typical Application Circuit2, you need to select LDO--Input voltage range 4V~15V(or higher) . lout>=100mA. Output voltage is preferred to set $4.2 \mathrm{~V} \sim 4.5 \mathrm{~V}$.

LDO need enough input \& output capacity ,please select suitable external parts and layout them according to LDO‘s datasheet.

XR2682

## LAYOUT CONSIDERATIONS

1 : The input capacitor, output capacitor, and the inductor should be placed as close as possible to the IC. to keep resistance very low and the switching loop very small for EMI performance

2 : The FB pin connection should be made as close to the load as possible so that the voltage at the load is the expected regulated value. and place FB network far from Switching node.

3 : Please make sure that the big current circuits are board and short to reduce the circuit Rdson, All ground connection must be tied together. Use a broad ground plane to establish the lowest resistance possible between all connections to achieve the best thermal and noise performance.

4: The switch node connection should be low resistance to reduce power losses.
5:The heavy copper board in big current output is recommended for high efficiency \& good heat dissipation.


## PCB LAYOUT GUIDE



XR2682

## TYPICAL PERFORMANCE CHARACTERISTICS

(L=2.2uH-Wurth 74437349022, Cin or Cout=22uF MLCC+220uF Ecap; D=MBRS410 ,if not mentioned)





Note: Efficiency data is based on demo test at $20^{\circ} \mathrm{C}$. If work at big current for long time, maybe thermal shutdown. its load capacity is related with heat dissipation conditions.

### 3.6Vin9Vout 50mA Switching



[^0]3.6Vin9Vout 1A Switching


XR2682
3.6Vin12Vout 50mA Switching


### 3.6Vin12Vout 1A Switching



9Vout Startup from Vin


9Vout Startup from EN


XR2682

## PACKAGE OUTLINE

## SOP8-PP PACKAGE OUTLINE AND DIMENSIONS



| SYMBOL | Dimension in <br> Millimeters |  | Dimension in <br> Inches |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 1.35 | 1.75 | 0.053 | 0.069 |
| A1 | 0.100 | 0.250 | 0.004 | 0.010 |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 |
| B | 0.330 | 0.510 | 0.013 | 0.020 |
| C | 0.190 | 0.250 | 0.007 | 0.010 |
| D | 4.700 | 5.100 | 0.185 | 0.201 |
| E | 3.800 | 4.000 | 0.150 | 0.157 |
| E1 | 5.800 | 6.300 | 0.228 | 0.248 |
| e | 1.27 |  | TYP | 0.050 |
| TYP |  |  |  |  |
| L | 0.400 | 1.270 | 0.016 | 0.050 |
| F | $0^{\circ}$ | $8^{\circ}$ | $0^{\circ}$ | $8^{\circ}$ |
| G | 2.26 | 2.56 | 0.089 | 0.101 |
|  | 3.15 | 3.45 | 0.124 | 0.136 |

In order to increase the driver current capability of XR2682 and improve the temperature of package, Please ensure Epad and enough ground PCB to release energy.


## X-ON Electronics

Largest Supplier of Electrical and Electronic Components
Click to view similar products for Switching Controllers category:
Click to view products by XySemi manufacturer:
Other Similar products are found below :
LV5065VB-TLM-H LV5066V-TLM-H LV5725JAZ-AH 633888R MP2908AGF AZ7500EP-E1 NCP1012AP133G NCP1217P133G
NCP1218AD65R2G NCP1234AD100R2G NCP1244BD065R2G NCP1336ADR2G NCP1587GDR2G NCP6153MNTWG
NCP81005MNTWG NCP81101BMNTXG NCP81205MNTXG HV9123NG-G-M934 IR35207MTRPBF ISL6367HIRZ CAT874-80ULGT3
SJ6522AG SJE6600 TLE63893GV50XUMA1 IR35215MTRPBF SG3845DM NCP1216P133G NCP1236DD65R2G NCP1247BD100R2G
NCP1250BP65G NCP4202MNR2G NCP4204MNTXG NCP6132AMNR2G NCP81141MNTXG NCP81142MNTXG NCP81172MNTXG
NCP81203MNTXG NCP81206MNTXG NX2155HCUPTR UC3845ADM UBA2051C IR35201MTRPBF MAX8778ETJ+
MAX17500AAUB+T MAX17411GTM+T MAX16933ATIR/V+ NCP1010AP130G NCP1063AD100R2G NCP1216AP133G
NCP1217AP100G


[^0]:    Suzhou XySemı Electronic lechnology Co., Limıted

